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74ABT543A Octal latched transceiver with dual enable; 3-stateRev. 5 — 3 November 2011Production

Product data sheet

General description 1.

The 74ABT543A high performance BiCMOS device combines low static and dynamic power dissipation with high speed and high output drive.

The 74ABT543A octal registered transceiver contains two sets of D-type latches for temporary storage of data flowing in either direction. Separate latch enable (LEAB, LEBA) and output enable (OEAB, OEBA) inputs are provided for each register to permit independent control of data transfer in either direction. The outputs are guaranteed to sink 64 mA.

Features and benefits 2.

- Combines 74ABT245 and 74ABT373 type functions in one device
- 8-bit octal transceiver with D-type latch
- Back-to-back registers for storage
- Separate controls for data flow in each direction
- Live insertion and extraction permitted
- Output capability: +64 mA to -32 mA
- Power-up 3-state
- Power-up reset
- Latch-up protection exceeds 500 mA per JESD78B class II level A
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V

Ordering information 3.

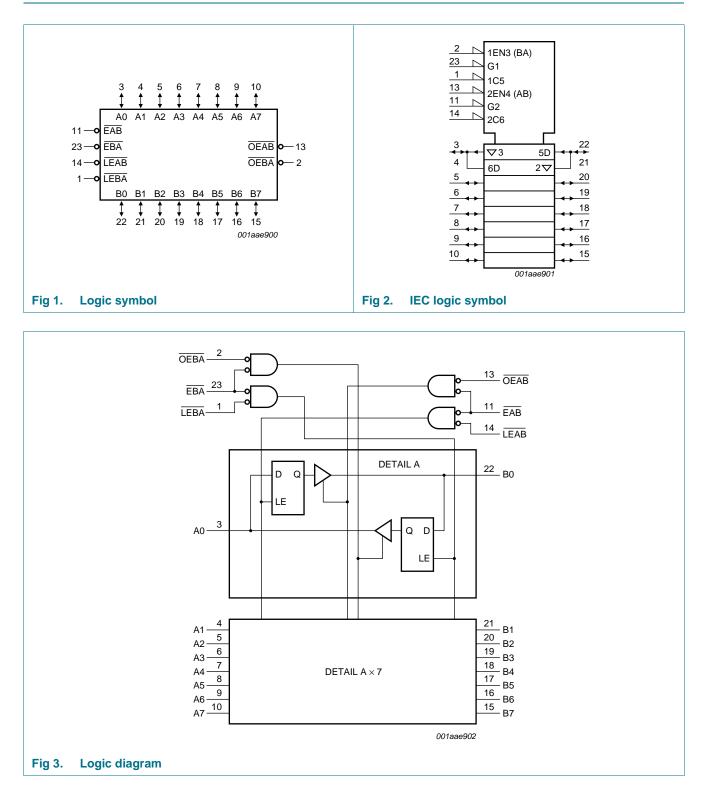
Table 1. **Ordering information**

| Type number | Package | | | | | | | | |
|-------------|-------------------|---------|--|----------|--|--|--|--|--|
| | Temperature range | Name | Description | Version | | | | | |
| 74ABT543AD | –40 °C to +85 °C | SO24 | plastic small outline package; 24 leads; body width 7.5 mm | SOT137-1 | | | | | |
| 74ABT543ADB | –40 °C to +85 °C | SSOP24 | plastic shrink small outline package; 24 leads; body width 5.3 mm | SOT340-1 | | | | | |
| 74ABT543APW | –40 °C to +85 °C | TSSOP24 | plastic thin shrink small outline package; 24 leads; body width 4.4 mm | SOT355-1 | | | | | |



Octal latched transceiver with dual enable; 3-state

4. Functional diagram

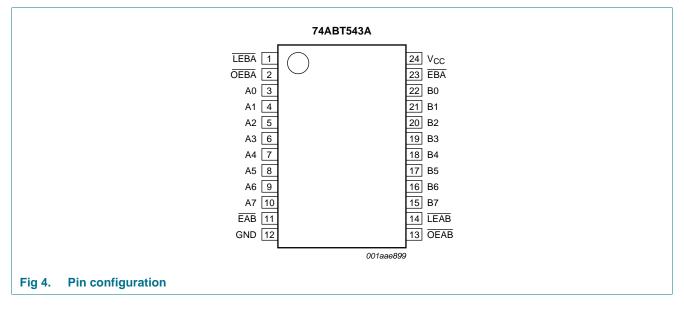


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5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|-----------------|--------------------------------|---|
| LEBA | 1 | B-to-A latch enable input (active LOW) |
| OEBA | 2 | B-to-A output enable input (active LOW) |
| A0 to A7 | 3, 4, 5, 6, 7, 8, 9, 10 | data input or output |
| EAB | 11 | A-to-B enable input (active LOW) |
| GND | 12 | ground (0 V) |
| OEAB | 13 | A-to-B output enable input (active LOW) |
| LEAB | 14 | A-to-B latch enable input (active LOW) |
| B0 to B7 | 22, 21, 20, 19, 18, 17, 16, 15 | data input or output |
| EBA | 23 | B-to-A enable input (active LOW) |
| V _{CC} | 24 | positive supply voltage |

Octal latched transceiver with dual enable; 3-state

6. Functional description

| Input | | | | Output | Status | |
|-------|------------|------------|----------|----------|------------------|--|
| OEXX | EXX | LEXX | An or Bn | Bn or An | | |
| Н | Х | Х | x | Z | disabled | |
| Х | Н | Х | Х | Z | | |
| L | \uparrow | L | h | Z | disabled + latch | |
| | | | I | Z | | |
| L | L | \uparrow | h | Н | latch + display | |
| | | | Ι | L | | |
| L | L | L | Н | Н | transparent | |
| | | | L | L | | |
| L | L | Н | Х | NC | hold | |

6.1 Function table

[1] H = HIGH voltage level;

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition of LEXX or EXX (XX = AB or BA);

L = LOW voltage level;

I = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition of LEXX or EXX (XX = AB or BA);

 \uparrow = LOW-to-HIGH clock transition of LEXX or EXX (XX = AB or BA);

NC = no change;

X = don't care;

Z = high-impedance OFF-state.

6.2 Description

The 74ABT543A contains two sets of eight D-type latches, with separate control pins for each set.

Using data flow from A-to-B as an example, when the A-to-B enable (\overline{EAB}) input, the A-to-B latch enable (\overline{LEAB}) input and the A-to-B output enable (\overline{OEAB}) input are all LOW, the A-to-B path is transparent.

A subsequent LOW-to-HIGH transition of the LEAB signal puts the A data into the latches where it is stored and the B outputs no longer change with the A inputs. With EAB and \overline{OEAB} both LOW, the 3-state B output buffers are active and display the data present at the outputs of the A latches.

Control of data flow from B-to-A is similar, but using the EBA, LEBA, and OEBA inputs.

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7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|-----------------------------------|-----------------|------|------|
| V _{CC} | supply voltage | | -0.5 | +7.0 | V |
| VI | input voltage | | <u>[1]</u> –1.2 | +7.0 | V |
| Vo | output voltage | output in OFF-state or HIGH-state | <u>[1]</u> –0.5 | +5.5 | V |
| I _{IK} | input clamping current | V ₁ < 0 V | -18 | - | mA |
| I _{OK} | output clamping current | V _O < 0 V | -50 | - | mA |
| lo | output current | output in LOW-state | - | 128 | mA |
| Tj | junction temperature | | [2] _ | 150 | °C |
| T _{stg} | storage temperature | | -65 | +150 | °C |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150 °C.

8. Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------|-------------------------------------|-------------|-----|-----|-----------------|------|
| V _{CC} | supply voltage | | 4.5 | - | 5.5 | V |
| VI | input voltage | | 0 | - | V _{CC} | V |
| V _{IH} | HIGH-level input voltage | | 2.0 | - | - | V |
| V _{IL} | LOW-level input voltage | | - | - | 0.8 | V |
| I _{OH} | HIGH-level output current | | -32 | - | - | mA |
| I _{OL} | LOW-level output current | | - | - | 64 | mA |
| $\Delta t / \Delta V$ | input transition rise and fall rate | | 0 | - | 10 | ns/V |
| T _{amb} | ambient temperature | in free air | -40 | - | +85 | °C |
| | | | | | | |

9. Static characteristics

Table 6. Static characteristics

| Symbol | Parameter | Conditions | | 25 °C | | –40 °C t | o +85 °C | Unit |
|---------------------|-----------------------------------|---|-------------------|-------|------|----------|----------------------|-------------|
| | | | Min | Тур | Max | Min | Max | |
| V _{IK} | input clamping voltage | $V_{CC} = 4.5 \text{ V}; \text{ I}_{IK} = -18 \text{ mA}$ | -1.2 | -0.9 | - | -1.2 | - | V |
| 011 | HIGH-level output | $V_{I} = V_{IL} \text{ or } V_{IH}$ | | | | | | |
| | voltage | V_{CC} = 4.5 V; I_{OH} = -3 mA | 2.5 | 3.2 | - | 2.5 | - | V |
| | | V_{CC} = 5.0 V; I_{OH} = -3 mA | 3.0 | 3.7 | - | 3.0 | - | V |
| | | V_{CC} = 4.5 V; I _{OH} = -32 mA | 2.0 | 2.3 | - | 2.0 | - | V |
| V _{OL} | LOW-level output voltage | $\label{eq:V_CC} \begin{array}{l} V_{CC} = 4.5 \; V; \; I_{OL} = 64 \; mA; \\ V_{I} = V_{IL} \; or \; V_{IH} \end{array}$ | - | 0.3 | 0.55 | - | 0.55 | V |
| V _{OL(pu)} | power-up LOW-level output voltage | V_{CC} = 5.5 V; I _O = 1 mA; V _I = GND or V _{CC} | - | 0.13 | 0.55 | - | 0.55 | V |
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Octal latched transceiver with dual enable; 3-state

| Symbol | Parameter | Conditions | | | 25 °C | | –40 °C t | o +85 °C | Unit |
|-----------------------|---------------------------------------|--|------------|------|-------|------|----------|----------|------|
| | | | | Min | Тур | Max | Min | Max | |
| l _l | input leakage current | V_{CC} = 5.5 V; V_I = GND or 5.5 V | | | | | | | |
| | | OEAB, OEBA | | - | ±0.01 | ±1.0 | - | ±1.0 | μΑ |
| | | An, Bn | | - | ±5.0 | ±100 | - | ±100 | μΑ |
| I _{OFF} | power-off leakage current | V_{CC} = 0.0 V; V_{I} or $V_{O} \leq 4.5$ V | | - | ±5.0 | ±100 | - | ±100 | μA |
| I _{O(pu/pd)} | power-up/power-down output current | $V_{CC} = 2.1 \text{ V}; V_O = 0.5 \text{ V};$ $V_I = GND \text{ or } V_{CC};$ $\overline{OEAB}, \overline{OEBA} \text{ don't care}$ | <u>[1]</u> | - | ±5.0 | ±50 | - | ±50 | μΑ |
| I _{OZ} | OFF-state output | V_{CC} = 5.5 V; V_I = V_{IL} or V_{IH} | | | | | | | |
| | current | $V_{O} = 2.7 V$ | | - | 5.0 | 50 | - | 50 | μΑ |
| | | $V_{O} = 0.5 V$ | | - | -5.0 | -50 | - | -50 | μΑ |
| I _{LO} | output leakage current | HIGH-state; $V_O = 5.5 V$; $V_{CC} = 5.5 V$; $V_I = GND$ or V_{CC} | | - | 5.0 | 50 | - | 50 | μA |
| lo | output current | V_{CC} = 5.5 V; V_{O} = 2.5 V | [2] | -180 | -65 | -40 | -180 | -40 | mA |
| I _{CC} | supply current | V_{CC} = 5.5 V; V_{I} = GND or V_{CC} | | | | | | | |
| | | outputs HIGH-state | | - | 110 | 250 | - | 250 | μΑ |
| | | outputs LOW-state | | - | 20 | 30 | - | 30 | mΑ |
| | | outputs disabled | | - | 110 | 250 | - | 250 | μΑ |
| ΔI _{CC} | additional supply current | per input pin; V_{CC} = 5.5 V; one input pin at 3.4 V, other inputs at V_{CC} or GND | <u>[3]</u> | - | 0.3 | 1.5 | - | 1.5 | mA |
| CI | input capacitance | $V_I = 0 V \text{ or } V_{CC}$ | | - | 4 | - | - | - | pF |
| C _{I/O} | input/output capacitance | outputs disabled; $V_O = 0 V$ or V_{CC} | | - | 7 | - | - | - | pF |

Table 6. Static characteristics ...continued

[1] This parameter is valid for any V_{CC} between 0 V and 2.1 V, with a transition time of up to 10 ms. From V_{CC} = 2.1 V to V_{CC} = 5 V \pm 10 %, a transition time of up to 100 μ s is permitted.

[2] Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

[3] This is the increase in supply current for each input at 3.4 V.

10. Dynamic characteristics

Table 7. Dynamic characteristics

GND = 0 V; for test circuit, see Figure 10.

| Symbol | Parameter | Conditions | 25 °C | 25 °C; V _{CC} = 5.0 V | | –40 °C to V _{CC} = 5.0 | | |
|-------------------|--|--|-------|--------------------------------|-----|------------------------------------|-----|----|
| | | | Min | Тур | Max | Min | Max | |
| t _{PLH} | | An to Bn or Bn to An; see Figure 5 | 1.0 | 2.9 | 4.5 | 1.0 | 5.2 | ns |
| propagation delay | LEBA to An or LEAB to Bn; see Figure 6 | 1.0 | 3.4 | 5.1 | 1.0 | 6.2 | ns | |
| t _{PHL} | HIGH to LOW | An to Bn or Bn to An; see Figure 5 | 1.9 | 3.6 | 5.2 | 1.9 | 5.7 | ns |
| | propagation delay | LEBA to An or LEAB to Bn; see Figure 6 | 2.1 | 4.3 | 6.0 | 2.1 | 6.7 | ns |
| 1211 011 01 | OFF-state to HIGH | OEBA to An, OEAB to Bn; see Figure 7 | 1.0 | 3.2 | 5.1 | 1.0 | 6.2 | ns |
| | propagation delay | EBA to An, EAB to Bn; see Figure 7 | 1.0 | 3.4 | 5.1 | 1.0 | 6.2 | ns |

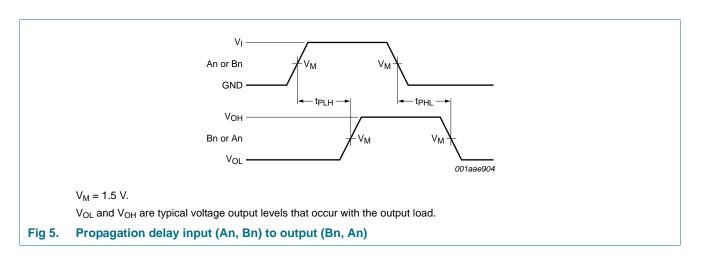
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|--------------------|--|---------------------------------------|
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Octal latched transceiver with dual enable; 3-state

| Symbol | Parameter | Conditions | 25 °C | ; V _{CC} = | 5.0 V | V -40 °C to +85 °C; V _{CC} = 5.0 V \pm 0.5 V | | Unit |
|--------------------|-------------------|--------------------------------------|-------|---------------------|-------|--|-----|------|
| | | | Min | Тур | Max | Min | Max | |
| t _{PZL} | OFF-state to LOW | OEBA to An, OEAB to Bn; see Figure 8 | 2.0 | 4.3 | 5.9 | 2.0 | 6.6 | ns |
| I | propagation delay | EBA to An, EAB to Bn; see Figure 8 | 2.0 | 4.4 | 6.1 | 2.0 | 6.8 | ns |
| t _{PHZ} | HIGH to OFF-state | OEBA to An, OEAB to Bn; see Figure 7 | 2.0 | 4.0 | 5.7 | 2.0 | 6.2 | ns |
| propagation delay | propagation delay | EBA to An, EAB to Bn; see Figure 7 | 2.0 | 3.6 | 5.4 | 2.0 | 5.9 | ns |
| | LOW to OFF-state | OEBA to An, OEAB to Bn; see Figure 8 | 1.0 | 3.0 | 4.6 | 1.0 | 5.0 | ns |
| | propagation delay | EBA to An, EAB to Bn; see Figure 8 | 1.0 | 3.0 | 4.6 | 1.0 | 5.0 | ns |
| t _{su(H)} | set-up time HIGH | An to LEAB, Bn to LEBA; see Figure 9 | 2.5 | 1.0 | - | 2.5 | - | ns |
| | | An to EAB, Bn to EBA; see Figure 9 | 3.5 | 1.3 | - | 3.5 | - | ns |
| t _{su(L)} | set-up time LOW | An to LEAB, Bn to LEBA; see Figure 9 | 3.0 | 1.4 | - | 3.0 | - | ns |
| | | An to EAB, Bn to EBA; see Figure 9 | 3.0 | 1.4 | - | 3.0 | - | ns |
| t _{h(H)} | hold time HIGH | LEAB to An, LEBA to Bn; see Figure 9 | +0.5 | -0.8 | - | 0.5 | - | ns |
| | | EAB to An, EBA to Bn; see Figure 9 | +0.5 | -0.8 | - | 0.5 | - | ns |
| t _{h(L)} | hold time LOW | LEAB to An, LEBA to Bn; see Figure 9 | +0.5 | -0.6 | - | 0.5 | - | ns |
| | | EAB to An, EBA to Bn; see Figure 9 | +0.5 | -0.6 | - | 0.5 | - | ns |
| t _{WL} | pulse width LOW | latch enable; see Figure 9 | 3.5 | 1.0 | - | 3.5 | - | ns |

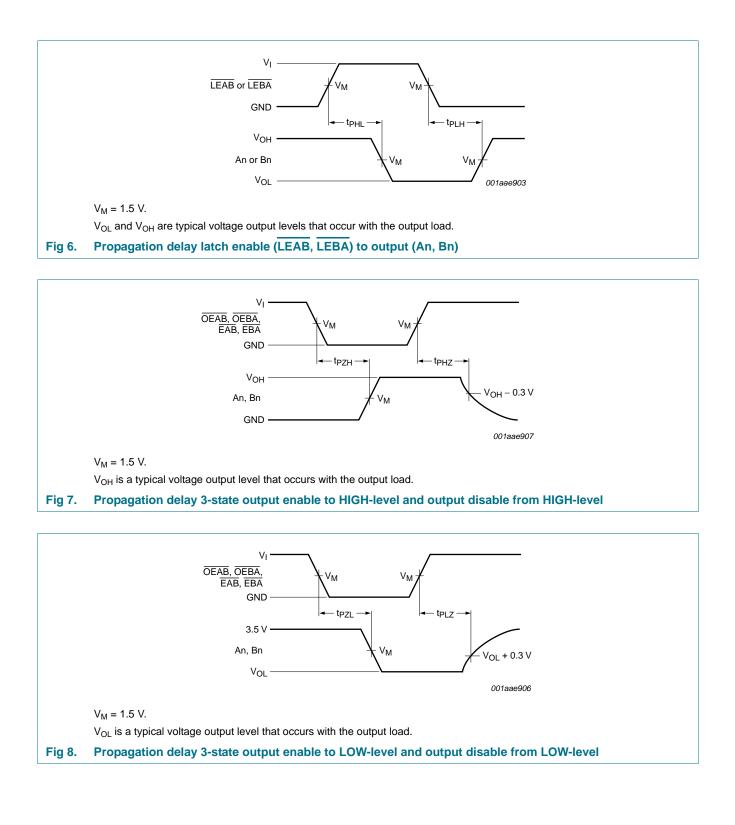
Table 7.Dynamic characteristics ... continuedGND = 0 V; for test circuit, see Figure 10.

11. Waveforms



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Octal latched transceiver with dual enable; 3-state

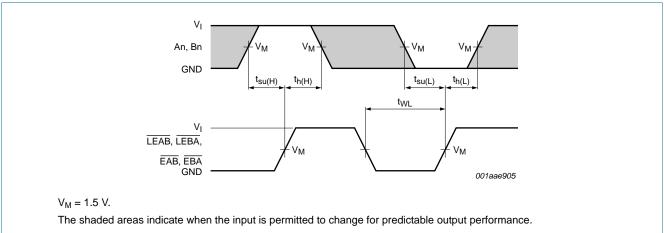


Fig 9. Data set-up and hold times and latch enable pulse width

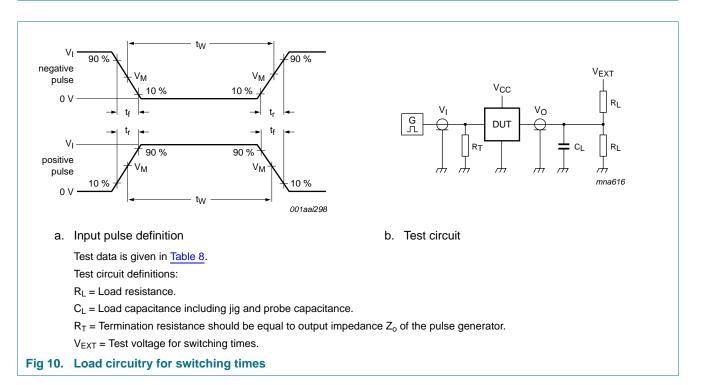


Table 8. Test data

| Input | | | Load | | V _{EXT} | | | |
|-------|-------|--------|---------------------------------|-------|------------------|-------------------------------------|-------------------------------------|-------------------------------------|
| VI | fı | tw | t _r , t _f | CL | RL | t _{PHL} , t _{PLH} | t _{PZH} , t _{PHZ} | t _{PZL} , t _{PLZ} |
| 3.0 V | 1 MHz | 500 ns | \leq 2.5 ns | 50 pF | 500 Ω | open | open | 7.0 V |

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12. Package outline

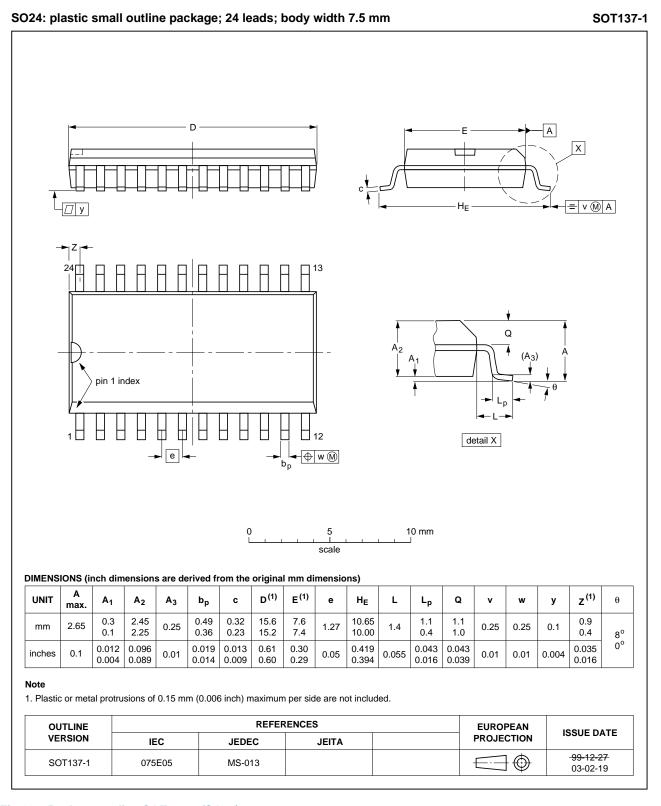


Fig 11. Package outline SOT137-1 (SO24)

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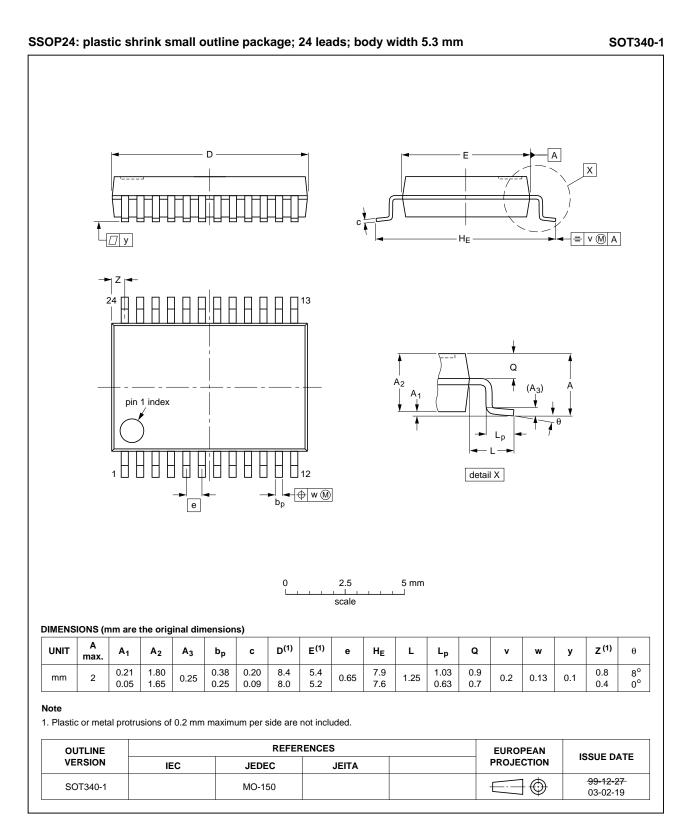


Fig 12. Package outline SOT340-1 (SSOP24)

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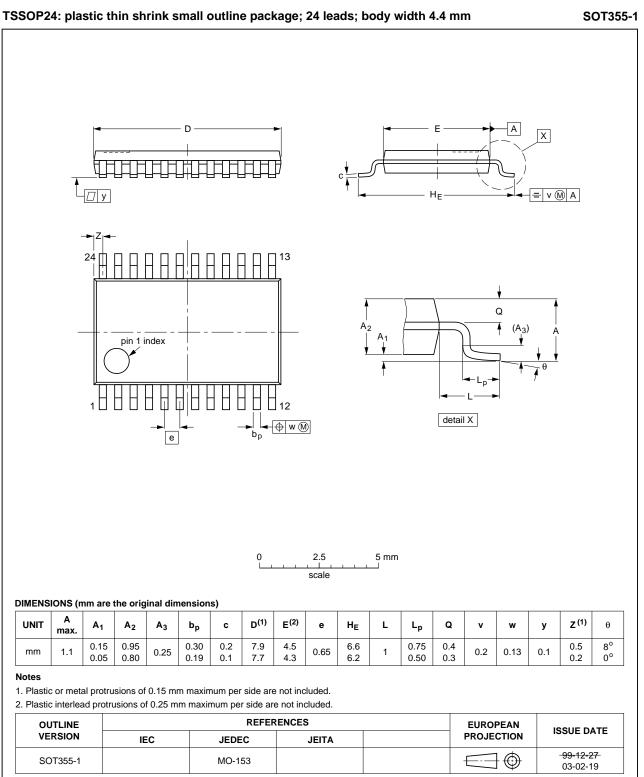


Fig 13. Package outline SOT355-1 (TSSOP24)

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13. Abbreviations

| Table 9. | Abbreviations |
|----------|---|
| Acronym | Description |
| BiCMOS | Bipolar Complementary Metal-Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| MM | Machine Model |
| | |

14. Revision history

Table 10.Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------|---------------------|-----------------------|---------------|---------------|
| 74ABT543A v.5 | 20111103 | Product data sheet | - | 74ABT543A v.4 |
| Modifications: | Legal pages updated | | | |
| 74ABT543A v.4 | 20100507 | Product data sheet | - | 74ABT543A v.3 |
| 74ABT543A v.3 | 20100126 | Product data sheet | - | 74ABT543A v.2 |
| 74ABT543A v.2 | 19980924 | Product specification | - | 74ABT543A v.1 |
| 74ABT543A v.1 | 19950419 | Product specification | - | - |

Octal latched transceiver with dual enable: 3-state

15. Legal information

15.1 Data sheet status

| Document status[1][2] | Product status ^[3] | Definition |
|--------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

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